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W83627DHG

WINBOND LPC I/O

Note: This document is for UBC, UBE and UBF version
except specified descriptions

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Data Sheet Revision History

	PAGES	DATES	VERSION	WEB VERSION	MAIN CONTENTS
1	N.A.	12/15/2005	0.1	N.A.	1. First published version.
2	N.A.	02/22/2006	0.2	N.A.	1. Add descriptions of the registers, functions,, AC/DC timing, and top marking
3	N.A.	03/15/2006	0.3	N.A.	1. Revise Table 8.1 and the timing chart of section 10.3.1 2. Add registers for AMDSDI at LDB, CRF5h,CRF6h and F7h(Bank1) 3. Swap LDB, CRF2h bit 0 and bit 1. 4. Modify the default values for LDA, CRFEh 5. Modify the descriptions of LD9, CR30h bit 0 and CRF7h bit 4. 6. Remove LDA, CRE9h bit4 ~ 3 7. Swap LDC, CRE0h bit3~0 and CRE5h bit7~4
4	N.A.	05/05/2006	0.4	N.A.	1. Add FDC, UART, Parallel Port and KBC interface descriptions 2. Remove all the descriptions about AMDSDI 3. Modify the diagrams and descriptions for Current Mode 4. Add two control bits for the selections of SYSFANOUT and CPUFANOUT0 output type at CR[24h] 5. Remove the description of the internal pulled-up resistor of Parallel Port 6. Modify the definitions of edge/level and enable/disable debounce circuit of GP30, GP31 and GP35 7. Modify the descriptions of LD7, CRF7h and LD9, CRE6h ~ CRE9h 8. Correct typos and grammatical mistakes
5	N.A.	05/15/2006	0.41	N.A.	1. Remove the remaining descriptions about AMDSDI in datasheet ver.0.4
6	N.A.	05/19/2006	0.42	N.A.	1. Add a note for Index# of FDC Interface and pin 83(GP42) of Serial Port & Infrared Port Interface in Pin Description 2. Reserve the bit 7 of LD0, CRF0h 3. Modify the descriptions of TRAK0#, WP#, RDATA# and DSKCHG# of FDC Interface 4. Modify the descriptions for strapping pins: HEFRAS, PENROM, PENKBC and EN_GTL 5. Modify the DC spec.
7	N.A.	06/23/2006	0.5	N.A.	1. Remove the note and renew the descriptions for Index# of FDC Interface. 2. Correct the descriptions of HM Device Bank 0, CR[12h] bit0. 3. Add two control bits for AUXFANOUT and CPUFAUT1 output type selection. 4. Add a new bit at LDC, CR[E8h] bit 1 for more PECL



	PAGES	DATES	VERSION	WEB VERSION	MAIN CONTENTS
					<p>clock selection.</p> <p>5. Modify the default values of HM Device Bank 0, CR[43h] bit 5,0 and CR[46h] bit 2~1.</p>
8	N.A.	09/29/2006	0.6	N.A.	<ol style="list-style-type: none"> 1. Add new chapters for Serial Peripheral Interface, Configuration Register Access Protocol, Power Management, Serialized IRQ, Watchdog Timer VID Inputs and Outputs, and PCI Reset Buffers. 2. Update the feature lists of the W83627DHG in Chapter 2 Features. 3. Add descriptions of PECI and SST and a table of SMBus in Chapter 5 Pin Description. 4. Add new sections of Caseopen and Beep Alarm Function in Chapter 7 Hardware Monitor. 5. Add Clock Input Timing, PECI & SST Timing, and SPI Timing in Chapter 21 Specifications. 6. Remove sections 9.4 and 9.5 (EXTFDD and EXT2FDD). 7. Modify the descriptions of Hardware Monitor Device, Bank 0, Index 59h, bits(6..4). 8. Add a beep control bit for VIN4 at Hardware Monitor Device, Bank 0, Index 57h, bit6. 9. Remove status bit of PME# status of MIDI IRQ event at Logical Device A, CRF4, bit 1. 10. Remove control bit of enable/disable PME# of MIDI at Logical Device A, CRF7, bit 1. 11. Modify the descriptions of Tape Drive Register in Chapter 10 Floppy Disk Controller. 12. Correct the description of Digital Input Register, bit (6-4) in Chapter 10 Floppy Disk Controller. 13. Remove the description of "MR pin" in Digital Output Register in Chapter 10 Floppy Disk Controller. 14. Adapt "Serial Flash Interface" to "Serial Peripheral Interface". 15. Modify "Absolute Maximum Ratings" in Chapter 21 Specifications. 16. Remove "V_{DD} is $5V \pm 10\%$ tolerance" from the description of DC Characteristics in Chapter 21 Specifications. 17. Update "S5_{cold} state" to "S5 state". 18. Remove the section of "AT Interface" in Chapter 10 Floppy Disk Controller.
9	N.A.	10/05/2006	1.0	N.A.	<ol style="list-style-type: none"> 1. Update AC Timing parameters and waveforms.
10	N.A.	12/12/2006	1.1	N.A.	<ol style="list-style-type: none"> 1. Update Table 9.1 and Table 9.2 in Chapter 9 Serial Peripheral Interface 2. Update CR2Ah in Chapter 20 Configuration Register 3. Modify CR24h bit 0 to reserved



	PAGES	DATES	VERSION	WEB VERSION	MAIN CONTENTS
					4. Use "Tbase" instead of "TControl" 5. Add the pins, registers description and AC timing for new ACPI function – VSBGATE#, ATXPGD, FTPRST, PWROK2 and SUSC#
11	N.A.	01/25/2007	1.2	N.A.	1. Modify the description for VSBGATE#, ATXPGD, FTPRST. 2. Revise the definition for Logical Device A, CR[E5h] bit 0. 3. Add new section of PWROK Generation in Chapter 14 Power Management Event. 4. Add new timing of VSBGATE# in Chapter 21 Specifications. 5. Modify the description of CR[2Ah], bits [7:4]. 6. Modify the "t1" timing of RSMRST#. 7. Modify the descriptions of 7.7.2 OVT# Interrupt Mode. 8. Modify the "t3" and "t4" timing in Table 14.4 and section 21.3.3
12	N.A.	03/28/2007	1.3	N.A.	1. Add a new DC spec. of RSMRST# PWROK for UBF version (In section 14.3 and 14.4) 2. Add LPC Timing in section 21.4 3. Remove redundant Power on/off and LRESET# Timing
13	N.A.	04/10/2007	1.4	N.A.	1. Modify LPC Timing in section 21.4

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Table of Contents-

1. GENERAL DESCRIPTION	1
2. FEATURES	2
3. BLOCK DIAGRAM	5
4. PIN LAYOUT	6
5. PIN DESCRIPTION	8
5.1 LPC Interface	9
5.2 FDC Interface	9
5.3 Multi-Mode Parallel Port	10
5.4 Serial Port & Infrared Port Interface	12
5.5 KBC Interface	14
5.6 Serial Peripheral Interface	14
5.7 Hardware Monitor Interface	15
5.8 PECI Interface	17
5.9 SST Interface	17
5.10 Advanced Configuration and Power Interface	17
5.11 General Purpose I/O Port	18
5.11.1 SMBus Interface	18
5.11.2 GPIO Power Source	18
5.11.3 GPIO-2 Interface	19
5.11.4 GPIO-3 Interface	20
5.11.5 GPIO-4 Interface	20
5.11.6 GPIO-5 Interface	21
5.11.7 GPIO-6 Interface	21
5.11.8 GPIO-4 with WDTO# / SUSLED Multi-function	22
5.12 Particular ACPI Function pins – both for UBE and UBF Version Only	22
5.13 POWER PINS	23
6. CONFIGURATION REGISTER ACCESS PROTOCOL	24
6.1 Configuration Sequence	25
6.1.1 Enter the Extended Function Mode	25
6.1.2 Configure the Configuration Registers	25
6.1.3 Exit the Extended Function Mode	26
6.1.4 Software Programming Example	26
7. HARDWARE MONITOR	28
7.1 General Description	28
7.2 Access Interfaces	28
7.2.1 LPC Interface	29
7.2.2 I ² C interface	30
7.3 Analog Inputs	31
7.3.1 Voltages Over 2.048 V or Less Than 0 V	31
7.3.2 Voltage Detection	32



7.3.3	Temperature Sensing.....	32
7.4	SST Command Summary	34
7.4.1	Command Summary	34
7.4.2	Combination Sensor Data Format.....	35
7.5	PECI.....	36
7.6	Fan Speed Measurement and Control.....	39
7.6.1	Fan Speed Measurement.....	39
7.6.2	Fan Speed Control	40
7.6.3	SMART FAN™ Control	41
7.7	Interrupt Detection.....	50
7.7.1	SMI# Interrupt Mode	50
7.7.2	OVT# Interrupt Mode	53
7.7.3	Caseopen Detection.....	54
7.7.4	BEEP Alarm Function	55
8.	HARDWARE MONITOR REGISTER SET	56
8.1	Address Port (Port x5h).....	56
8.2	Data Port (Port x6h)	56
8.3	SYSFANOUT PWM Output Frequency Configuration Register - Index 00h (Bank 0).....	57
8.4	SYSFANOUT Output Value Select Register - Index 01h (Bank 0).....	57
8.5	CPUFANOUT0 PWM Output Frequency Configuration Register - Index 02h (Bank 0)	58
8.6	CPUFANOUT0 Output Value Select Register - Index 03h (Bank 0)	59
8.7	FAN Configuration Register I - Index 04h (Bank 0)	59
8.8	SYSTIN Target Temperature Register/ SYSFANIN Target Speed Register - Index 05h (Bank 0).....	60
8.9	CPUTIN Target Temperature Register/ CPUFANIN0 Target Speed Register - Index 06h (Bank 0).....	61
8.10	Tolerance of Target Temperature or Target Speed Register - Index 07h (Bank 0).....	61
8.11	SYSFANOUT Stop Value Register - Index 08h (Bank 0)	62
8.12	CPUFANOUT0 Stop Value Register - Index 09h (Bank 0).....	62
8.13	SYSFANOUT Start-up Value Register - Index 0Ah (Bank 0)	63
8.14	CPUFANOUT0 Start-up Value Register - Index 0Bh (Bank 0)	63
8.15	SYSFANOUT Stop Time Register - Index 0Ch (Bank 0).....	64
8.16	CPUFANOUT0 Stop Time Register - Index 0Dh (Bank 0)	64
8.17	Fan Output Step Down Time Register - Index 0Eh (Bank 0).....	65
8.18	Fan Output Step Up Time Register - Index 0Fh (Bank 0).....	65
8.19	AUXFANOUT PWM Output Frequency Configuration Register - Index 10h (Bank 0)	66
8.20	AUXFANOUT Output Value Select Register - Index 11h (Bank 0).....	66
8.21	FAN Configuration Register II - Index 12h (Bank 0)	67
8.22	AUXTIN Target Temperature Register/ AUXFANIN0 Target Speed Register - Index 13h (Bank 0).....	68
8.23	Tolerance of Target Temperature or Target Speed Register - Index 14h (Bank 0).....	69
8.24	AUXFANOUT Stop Value Register - Index 15h (Bank 0)	69
8.25	AUXFANOUT Start-up Value Register - Index 16h (Bank 0).....	70



8.26	AUXFANOUT Stop Time Register - Index 17h (Bank 0)	70
8.27	OVT# Configuration Register - Index 18h (Bank 0)	71
8.28	Reserved Registers - Index 19h ~ 1Fh (Bank 0)	71
8.29	Value RAM — Index 20h ~ 3Fh (Bank 0).....	71
8.30	Configuration Register - Index 40h (Bank 0).....	73
8.31	Interrupt Status Register 1 - Index 41h (Bank 0)	73
8.32	Interrupt Status Register 2 - Index 42h (Bank 0)	74
8.33	SMI# Mask Register 1 - Index 43h (Bank 0)	75
8.34	SMI# Mask Register 2 - Index 44h (Bank 0).....	75
8.35	Reserved Register - Index 45h (Bank 0).....	75
8.36	SMI# Mask Register 3 - Index 46h (Bank 0).....	75
8.37	Fan Divisor Register I - Index 47h (<i>Bank 0</i>).....	76
8.38	Serial Bus Address Register - Index 48h (Bank 0)	77
8.39	CPUFANOUT0/AUXFANOUT monitor Temperature source select register - Index 49h (Bank 0).....	77
8.40	CPUFANOUT1 Monitor Temperature Source Select Register - Index 4Ah (Bank 0).....	78
8.41	Fan Divisor Register II - Index 4Bh (Bank 0)	79
8.42	SMI#/OVT# Control Register - Index 4Ch (Bank 0)	79
8.43	FAN IN/OUT Control Register - Index 4Dh (Bank 0)	80
8.44	Register 50h ~ 5Fh Bank Select Register - Index 4Eh (Bank 0)	81
8.45	Winbond Vendor ID Register - Index 4Fh (Bank 0)	81
8.46	Reserved Register - Index 50h ~ 55h (Bank 0)	82
8.47	BEEP Control Register 1 - Index 56h (Bank 0).....	82
8.48	BEEP Control Register 2 - Index 57h (Bank 0).....	83
8.49	Chip ID - Index 58h (Bank 0).....	84
8.50	Diode Selection Register - Index 59h (Bank 0).....	84
8.51	Reserved Register - Index 5Ah ~ 5Ch (Bank 0)	85
8.52	VBAT Monitor Control Register - Index 5Dh (Bank 0)	85
8.53	Critical Temperature and Current Mode Enable Register - Index 5Eh (Bank 0)	86
8.54	Reserved Register - Index 5Fh (Bank 0)	87
8.55	CPUFANOUT1 PWM Output Frequency Configuration Register - Index 60h (Bank 0)	87
8.56	CPUFANOUT1 Output Value Select Register - Index 61h (Bank 0)	87
8.57	FAN Configuration Register III - Index 62h (Bank 0)	88
8.58	Target Temperature Register/CPUFANIN1 Target Speed Register - Index 63h (Bank 0) ...	89
8.59	CPUFANOUT1 Stop Value Register - Index 64h (Bank 0).....	89
8.60	CPUFANOUT1 Start-up Value Register - Index 65h (Bank 0)	90
8.61	CPUFANOUT1 Stop Time Register - Index 66h (Bank 0)	90
8.62	CPUFANOUT0 Maximum Output Value Register - Index 67h (Bank 0).....	91
8.63	CPUFANOUT0 Output Step Value Register - Index 68h (Bank 0)	91
8.64	CPUFANOUT1 Maximum Output Value Register - Index 69h (Bank 0).....	92
8.65	CPUFANOUT1 Output Step Value Register - Index 6Ah (Bank 0).....	92
8.66	SYSFANOUT Critical Temperature register - Index 6Bh (Bank 0)	93



8.67	CPUFANOUT0 Critical Temperature Register - Index 6Ch (Bank 0)	93
8.68	AUXFANOUT Critical Temperature Register - Index 6Dh (Bank 0)	93
8.69	CPUFANOUT1 Critical Temperature Register - Index 6Eh (Bank 0)	94
8.70	CPUTIN Temperature Sensor Temperature (High Byte) Register - Index 50h (Bank 1).....	94
8.71	CPUTIN Temperature Sensor Temperature (Low Byte) Register - Index 51h (Bank 1)	95
8.72	CPUTIN Temperature Sensor Configuration Register - Index 52h (Bank 1).....	95
8.73	CPUTIN Temperature Sensor Hysteresis (High Byte) Register - Index 53h (Bank 1)	96
8.74	CPUTIN Temperature Sensor Hysteresis (Low Byte) Register - Index 54h (Bank 1)	96
8.75	CPUTIN Temperature Sensor Over-temperature (High Byte) Register - Index 55h (Bank1)	97
8.76	CPUTIN Temperature Sensor Over-temperature (Low Byte) Register - Index 56h (Bank 1).....	97
8.77	AUXTIN Temperature Sensor Temperature (High Byte) Register - Index 50h (Bank 2).....	98
8.78	AUXTIN Temperature Sensor Temperature (Low Byte) Register - Index 51h (Bank 2).....	98
8.79	AUXTIN Temperature Sensor Configuration Register - Index 52h (Bank 2)	98
8.80	AUXTIN Temperature Sensor Hysteresis (High Byte) Register - Index 53h (Bank 2).....	99
8.81	AUXTIN Temperature Sensor Hysteresis (Low Byte) Register - Index 54h (Bank 2)	99
8.82	AUXTIN Temperature Sensor Over-temperature (High Byte) Register - Index 55h (Bank 2).....	100
8.83	AUXTIN Temperature Sensor Over-temperature (Low Byte) Register - Index 56h (Bank 2).....	100
8.84	Interrupt Status Register 3 - Index 50h (Bank 4)	101
8.85	SMI# Mask Register 4 - Index 51h (Bank 4)	102
8.86	Reserved Register - Index 52h (Bank 4).....	102
8.87	BEEP Control Register 3 - Index 53h (Bank 4).....	102
8.88	SYSTIN Temperature Sensor Offset Register - Index 54h (Bank 4)	103
8.89	CPUTIN Temperature Sensor Offset Register - Index 55h (Bank 4).....	103
8.90	AUXTIN Temperature Sensor Offset Register - Index 56h (Bank 4)	104
8.91	Reserved Register - Index 57h-58h (Bank 4)	104
8.92	Real Time Hardware Status Register I - Index 59h (Bank 4).....	104
8.93	Real Time Hardware Status Register II - Index 5Ah (Bank 4)	105
8.94	Real Time Hardware Status Register III - Index 5Bh (Bank 4)	106
8.95	Reserved Register - Index 5Ch ~ 5Fh (Bank 4).....	107
8.96	Value RAM 2 — Index 50h-59h (Bank 5).....	107
8.97	Reserved Register - Index 50h ~ 57h (Bank 6)	107
9.	SERIAL PERIPHERAL INTERFACE.....	108
9.1	Using the SPI Interface via the LPC	108
10.	FLOPPY DISK CONTROLLER.....	111
10.1	FDC Functional Description	111
10.1.1	FIFO (Data).....	111
10.1.2	Data Separator.....	112
10.1.3	Write Precompensation.....	112
10.1.4	Perpendicular Recording Mode.....	112
10.1.5	FDC Core.....	112



10.1.6 FDC Commands	113
10.2 Register Descriptions	124
10.2.1 Status Register A (SA Register) (Read base address + 0)	124
10.2.2 Status Register B (SB Register) (Read base address + 1)	126
10.2.3 Digital Output Register (DO Register) (Write base address + 2).....	128
10.2.4 Tape Drive Register (TD Register) (Read base address + 3)	128
10.2.5 Main Status Register (MS Register) (Read base address + 4)	129
10.2.6 Data Rate Register (DR Register) (Write base address + 4)	129
10.2.7 FIFO Register (R/W base address + 5).....	131
10.2.8 Digital Input Register (DI Register) (Read base address + 7)	133
10.2.9 Configuration Control Register (CC Register) (Write base address + 7).....	134
11. UART PORT	136
11.1 Universal Asynchronous Receiver/Transmitter (UART A, UART B).....	136
11.2 Register Description.....	136
11.2.1 UART Control Register (UCR) (Read/Write).....	136
11.2.2 UART Status Register (USR) (Read/Write).....	139
11.2.3 Handshake Control Register (HCR) (Read/Write).....	140
11.2.4 Handshake Status Register (HSR) (Read/Write)	140
11.2.5 UART FIFO Control Register (UFR) (Write only)	141
11.2.6 Interrupt Status Register (ISR) (Read only)	142
11.2.7 Interrupt Control Register (ICR) (Read/Write)	143
11.2.8 Programmable Baud Generator (BLL/BHL) (Read/Write)	143
11.2.9 User-defined Register (UDR) (Read/Write).....	144
12. PARALLEL PORT	145
12.1 Printer Interface Logic.....	145
12.2 Enhanced Parallel Port (EPP).....	146
12.2.1 Data Port (Data Swapper).....	147
12.2.2 Printer Status Buffer.....	147
12.2.3 Printer Control Latch and Printer Control Swapper	147
12.2.4 EPP Address Port	148
12.2.5 EPP Data Port 0-3	148
12.2.6 EPP Pin Descriptions.....	149
12.2.7 EPP Operation	149
12.3 Extended Capabilities Parallel (ECP) Port.....	150
12.3.1 ECP Register and Bit Map	151
12.3.2 Data and ecpAFifo Port.....	152
12.3.3 Device Status Register (DSR).....	152
12.3.4 Device Control Register (DCR)	153
12.3.5 CFIFO (Parallel Port Data FIFO) Mode = 010.....	153
12.3.6 ECPDFIFO (ECP Data FIFO) Mode = 011	153
12.3.7 TFIFO (Test FIFO Mode) Mode = 110	154
12.3.8 CNFGA (Configuration Register A) Mode = 111	154
12.3.9 CNFGB (Configuration Register B) Mode = 111	154



12.3.10 ECR (Extended Control Register) Mode = all	155
12.3.11 ECP Pin Descriptions.....	156
12.3.12 ECP Operation.....	157
12.3.13 FIFO Operation	158
12.3.14 DMA Transfers.....	158
12.3.15 Programmed I/O (NON-DMA) Mode	158
13. KEYBOARD CONTROLLER	159
13.1 Output Buffer	159
13.2 Input Buffer.....	159
13.3 Status Register.....	160
13.4 Commands	160
13.5 Hardware GATEA20/Keyboard Reset Control Logic	162
13.5.1 KB Control Register	162
13.5.2 Port 92 Control Register.....	163
14. POWER MANAGEMENT EVENT	164
14.1 Power Control Logic.....	164
14.1.1 PSON# Logic	165
14.1.2 AC Power Failure Resume.....	166
14.2 Wake Up the System by Keyboard and Mouse	167
14.2.1 Waken up by Keyboard events	167
14.2.2 Waken up by Mouse events.....	167
14.3 Resume Reset Logic.....	168
14.4 PWROK Generation	169
14.4.1 The Relation among PWROK/PWROK2, ATXPGD and FTPRST# - both for UBE and UBF Version Only.....	170
15. SERIALIZED IRQ.....	173
15.1 Start Frame	173
15.2 IRQ/Data Frame	174
15.3 Stop Frame.....	175
16. WATCHDOG TIMER	176
17. GENERAL PURPOSE I/O	177
18. VID INPUTS AND OUTPUTS	178
18.1 VID Input Detection	178
18.2 VID Output Control.....	178
19. PCI RESET BUFFERS	179
20. CONFIGURATION REGISTER	180
20.1 Chip (Global) Control Register	180
20.2 Logical Device 0 (FDC)	187
20.3 Logical Device 1 (Parallel Port).....	190
20.4 Logical Device 2 (UART A)	191
20.5 Logical Device 3 (UART B)	191
20.6 Logical Device 5 (Keyboard Controller)	193



20.7	Logical Device 6 (Serial Peripheral Interface).....	194
20.8	Logical Device 7 (GPIO6)	195
20.9	Logical Device 8 (WDTO# & PLED)	196
20.10	Logical Device 9 (GPIO2, GPIO3, GPIO4, GPIO5)	198
20.11	Logical Device A (ACPI).....	202
20.12	Logical Device B (Hardware Monitor)	210
20.13	Logical Device C (PECI, SST)	212
21.	SPECIFICATIONS	216
21.1	Absolute Maximum Ratings	216
21.2	DC CHARACTERISTICS	216
21.3	AC CHARACTERISTICS	225
21.3.1	AC Power Failure Resume Timing.....	225
21.3.2	VSBGATE# Timing – for UBE and UBF Version Only	230
21.3.3	Clock Input Timing	231
21.3.4	PECI and SST Timing.....	232
21.3.5	SPI Timing	233
21.3.6	SMBus Timing.....	234
21.3.7	Floppy Disk Drive Timing	235
21.3.8	UART/Parallel Port.....	236
21.3.9	Parallel Port Mode Parameters	238
21.3.10	Parallel Port	239
21.3.11	KBC Timing Parameters	248
21.3.12	GPIO Timing Parameters.....	251
21.4	LPC Timing.....	253
22.	TOP MARKING SPECIFICATION	254
23.	PACKAGE SPECIFICATION	255



1. GENERAL DESCRIPTION

The W83627DHG is a member of Winbond's Super I/O product line. This family features the LPC (Low Pin Count) interface. This interface is more economical than its ISA counterpart, in that it has approximately forty pins fewer, yet still provides as great performance. In addition, the improvement allows even more efficient operation of software, BIOS and device drivers.

In addition to providing an LPC interface for I/O, the W83627DHG monitors several critical parameters in PC hardware, including power supply voltages, fan speeds, and temperatures. In terms of temperature monitoring, the W83627DHG adopts the Current Mode (dual current source) approach. The W83627DHG also supports the Smart Fan control system, including "SMART FAN™ I and SMART FAN™ III, which makes the system more stable and user-friendly.

The W83627DHG supports four -- 360K, 720K, 1.2M, 1.44M, or 2.88M -- disk drive types and data transfer rates of 250 Kb/s, 300 Kb/s, 500 Kb/s, 1 Mb/s, and 2 Mb/s. The disk drive adapter supports the functions of floppy disk drive controller (compatible with the industry standard 82077/ 765), data separator, write pre-compensation circuit, decode logic, data rate selection, clock generator, drive interface control logic, and interrupt and DMA logic. Such a wide range of functions integrated into one W83627DHG greatly reduces the number of required components to interface with floppy disk drives.

The W83627DHG provides two high-speed serial communication ports (UARTs), one of which provides IR functions IrDA 1.0 (SIR for 1.152K bps). Each UART includes a 16-byte send/receive FIFO, a programmable baud rate generator, complete modem-control capability, and a processor interrupt system. Both UARTs support legacy speeds up to 115.2K bps as well as even higher baud rates of 230K, 460K, or 921K bps to support higher speed modems.

The W83627DHG supports the PC-compatible printer port (SPP), the bi-directional printer port (BPP), the enhanced parallel port (EPP) and the extended capabilities port (ECP).

The W83627DHG provides a bridge of the Low Pin Count interface to Serial Peripheral Interface (SPI) that supports up to 8M bits serial flash ROM. The W83627DHG provides flexible I/O control functions through a set of 40 general purpose I/O (GPIO) ports. These GPIO ports may serve as simple I/O ports or may be individually configured to provide alternative functions.

The W83627DHG supports the SST (Simple Serial Transport) interface and Intel® PECL (Platform Environment Control Interface).

The W83627DHG fully complies with the Microsoft© PC98, PC99 and PC2001 System Design Guides and meets the requirements of ACPI.

The configuration registers inside the W83627DHG support mode selection, function enable and disable, and power-down selection. Furthermore, the configurable PnP features are compatible with the plug-and-play feature in Windows 95/98/2000/XP™, making the allocation of the system resources more efficient than ever.

One special characteristic of the Super I/O product line is the separation of the power supply in normal operation from that in standby operation. Please pay attention to the layout of these two power supplies to avoid short circuits. Otherwise, the feature will not function.



2. FEATURES

General

- Meet LPC Spec. 1.01
- Support LDRQ# (LPC DMA), SERIRQ (Serialized IRQ)
- Integrated hardware monitor functions
- Compliant with Microsoft PC98/PC99/PC2001 System Design Guide
- Support DPM (Device Power Management), ACPI (Advanced Configuration and Power Interface)
- Programmable configuration settings
- Single 24- or 48-MHz clock input
- Support selective pins of 5 V tolerance

FDC

- Variable write pre-compensation with track-selection capability
- Support vertical recording format
- DMA-enable logic
- 16-byte data FIFOs
- Support floppy disk drives and tape drives
- Detect all overrun and underrun conditions
- Built-in address mark detection circuit to simplify the read electronics
- FDD anti-virus functions with software write protect and FDD-write enable signal (write data signal forced to be inactive)
- Support 3.5-inch or 5.25-inch floppy disk drives
- Compatible with industry standard 82077
- 360K / 720K / 1.2M / 1.44M / 2.88M formats
- 250K, 300K, 500K, 1M, 2M bps data transfer rate
- Support 3-mode FDD and its Windows driver

UART

- Two high-speed, 16550-compatible UARTs with 16-byte send / receive FIFOs
- Fully programmable serial-interface characteristics:
 - 5, 6, 7 or 8-bit characters
 - Even, odd or no parity bit generation/detection
 - 1, 1.5 or 2 stop-bit generation
- Internal diagnostic capabilities:
 - Loop-back controls for communications link fault isolation
 - Break, parity, overrun, framing error simulation
- Programmable baud rate generator allows division of clock source by any value from 1 to $(2^{16}-1)$ ¹⁶
- Maximum baud rate for clock source 14.769 MHz is up to 921K bps. The baud rate at 24 MHz is 1.5 M bps.



Parallel Port

- Compatible with IBM parallel port
- Support PS/2-compatible bi-directional parallel port
- Support Enhanced Parallel Port (EPP) - Compatible with IEEE 1284 specification
- Support Extended Capabilities Port (ECP) - Compatible with IEEE 1284 specification
- Enhanced printer port back-drive current protection

Keyboard Controller

- 8042-based keyboard controller
- Asynchronous Access to two data registers and one status register
- Software-compatible with 8042
- Support PS/2 mouse
- Support Port 92
- Support both interrupt and polling modes
- Fast Gate A20 and Hardware Keyboard Reset
- 6, 8, 12, or 16 MHz operating frequency

Hardware Monitor Functions

- Smart Fan control system, supporting the functions of SMART FAN™ I -- “Thermal Cruise™” and “Speed Cruise™” modes, and SMART FAN™ III
- Programmable threshold temperature to speed fan fully while current temperature exceeds this threshold in the Thermal Cruise™ mode
- Three thermal inputs from the different combinations of remote thermistors, and the thermal diode output
- Support Current Mode (dual current source) temperature sensing method
- Nine voltage inputs (CPUVCORE, VIN[0..3] and 3VCC, AVCC , 3VSB, VBAT)
- Five fan-speed monitoring inputs
- Four fan-speed controls
- Dual mode for fan control (PWM and DC)
- Built-in case open detection circuit
- Programmable hysteresis and setting points for all monitored items
- Over-temperature indicator output
- Issue SMI#, OVT# to activate system protection
- Winbond Hardware Doctor™ support
- Eight VID inputs / outputs
- Provide I²C interface to read / write registers

Serial Peripheral Interface

- Support up to 8M bits SPI Flash Memory with clock up to 33 MHz
- Support Mode 0 and Mode 3



Infrared

- Support IrDA version 1.0 SIR protocol with maximum baud rate up to 115.2K bps
- Support SHARP ASK-IR protocol with maximum baud rate up to 57,600 bps

General Purpose I/O Ports

- 40 programmable general purpose I/O ports
- GPIO port 4 supports the optional functions of Watchdog Timer Out and Suspend LED Output
- GP30, GP31 and GP35 can distinguish whether the input pins undergo any transitions by reading the registers. All of the 3 GPIOs can assert PSOUT# or PME# to wake up the system if each of them undergoes any transition.

OnNow Functions

- Keyboard Wake-Up by programmable keys
- Mouse Wake-Up by programmable buttons
- OnNow Wake-Up from all of the ACPI sleeping states (S1-S5)

Simple Serial Transport™ Interface

- SST temperature and voltage Combination Sensor command support
- Support SST 0.9 Specification

PECI Interface

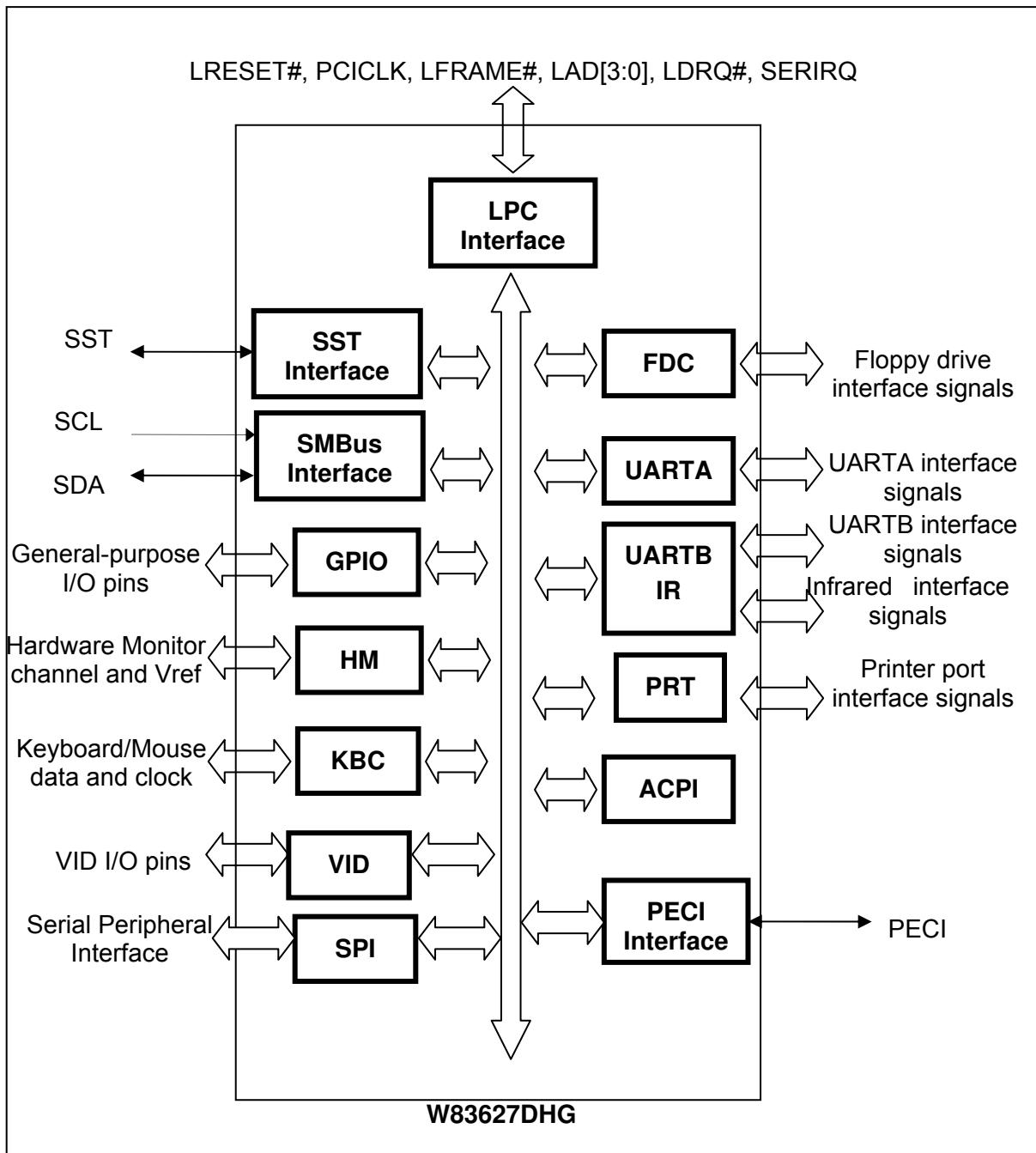
- Support PECI 1.0 Specification
- Support 4 CPU addresses and 2 domains per CPU address

Package

- 128-pin QFP
- Pb-free/RoHS

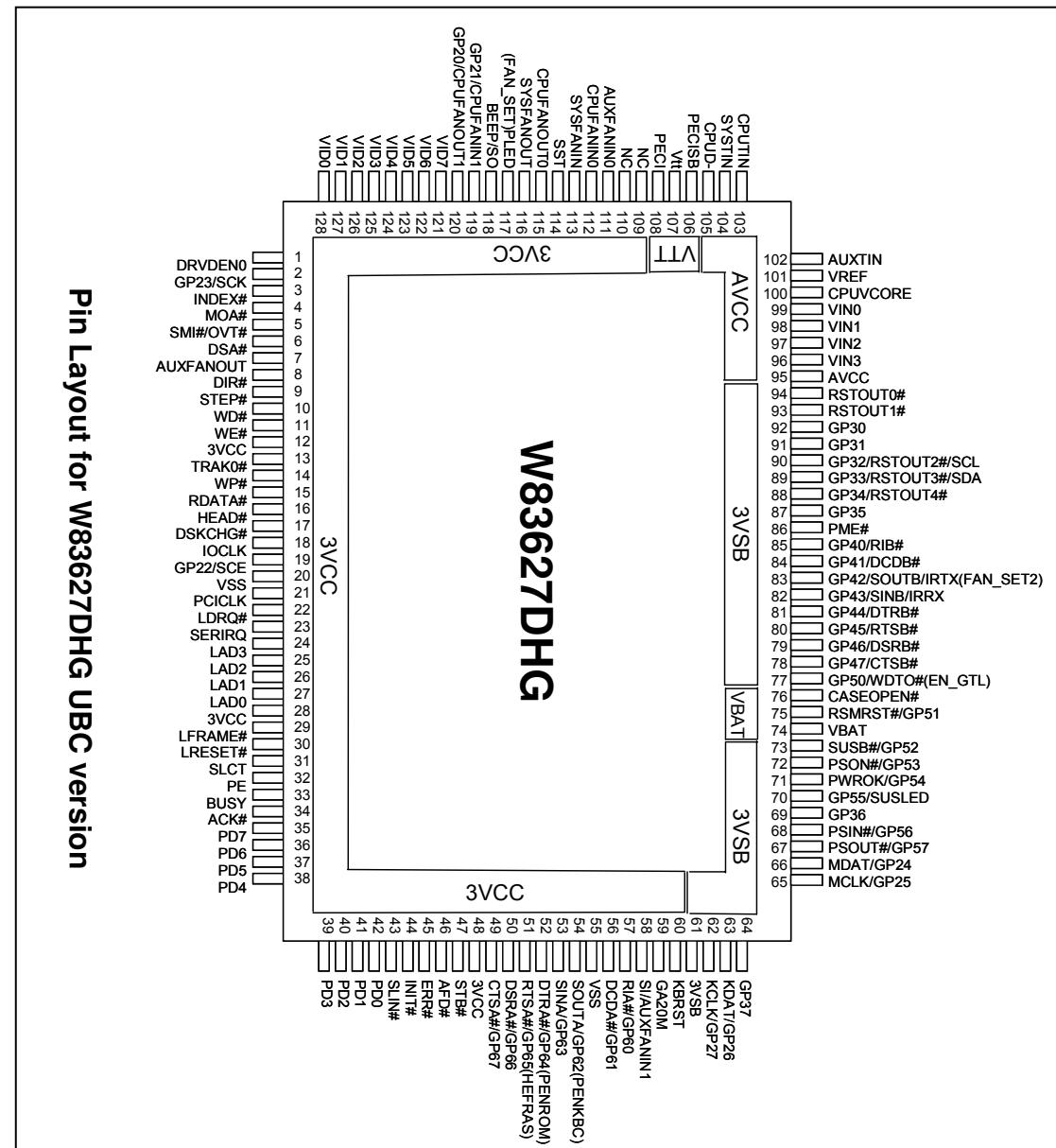


3. BLOCK DIAGRAM



W83627DHG

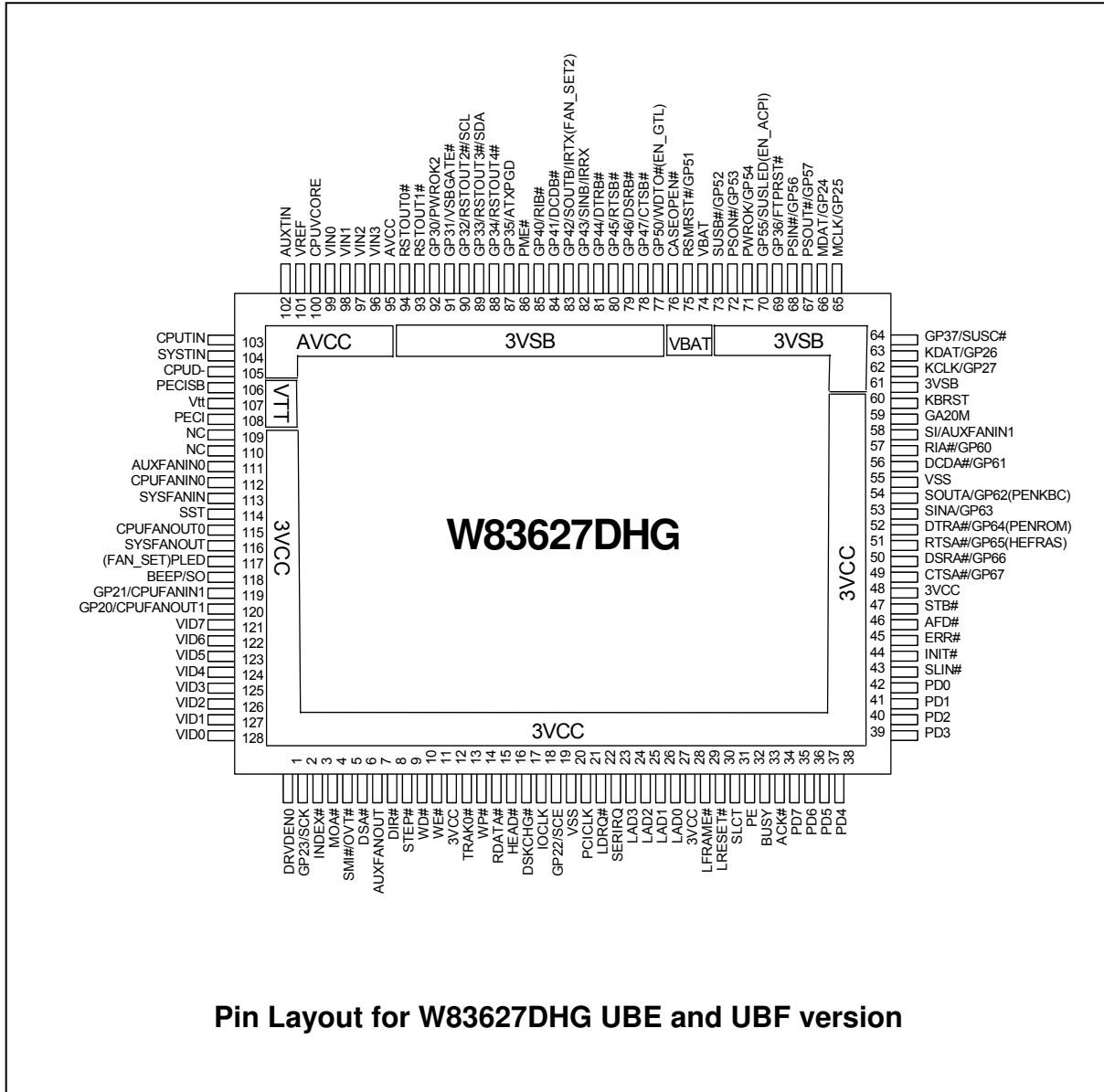
4. PIN LAYOUT



Pin Layout for W83627DHG UBC version

W83627DHG

winbond





5. PIN DESCRIPTION

Note: Please refer to Section 21.2 DC CHARACTERISTICS for details.

AOUT	- Analog output pin
AIN	- Analog input pin
IN _{cd}	- CMOS-level input pin with internal pull-down resistor
IN _{cs}	- CMOS-level, Schmitt-trigger input pin
IN _{csu}	- CMOS-level, Schmitt-trigger input pin with internal pull-up resistor
IN _t	- TTL-level input pin
IN _{td}	- TTL-level input pin with internal pull-down resistor
IN _{ts}	- TTL-level, Schmitt-trigger input pin
IN _{tp3}	- 3.3V, TTL-level input pin
IN _{tp3}	- 3.3V TTL level Schmitt-trigger input pin
IN _{tu}	- TTL-level input pin with internal pull-up resistor
I/O ₈	- bi-directional pin with 8-mA source-sink capability
I/O _{8t}	- TTL-level, bi-directional pin with 8-mA source-sink capability
I/O ₁₂	- bi-directional pin with 12-mA source-sink capability
I/O _{12t}	- TTL-level, bi-directional pin with 12-mA source-sink capability
I/O _{12ts}	- Schmitt-trigger, bi-directional pin with 12-mA source-sink capability
I/O _{12tp3}	- 3.3V, TTL-level, bi-directional pin with 12-mA source-sink capability
I/O _{8t}	- TTL-level, bi-directional pin. Open-drain output with 8-mA sink capability
I/O ₁₂	- Bi-directional pin. Open-drain output with 12-mA sink capability
I/O _{12t}	- TTL-level bi-directional pin. Open-drain output with 12-mA sink capability
I/O _{12cs}	- CMOS-level, bi-directional, Schmitt-trigger pin. Open-drain output with 12-mA sink capability
I/O _{12ts}	- TTL-level, bi-directional, Schmitt-trigger pin. Open-drain output with 12-mA sink capability
I/O _{12tp3}	- 3.3V, TTL-level, bi-directional pin. Open-drain output with 12-mA sink capability
I/O _{16t}	- TTL-level, bi-directional pin. Open-drain output with 16-mA sink capability
I/O _{16ts}	- Schmitt-trigger, bi-directional pin. Open-drain output with 16-mA sink capability
I/O _{16cs}	- CMOS-level, Schmitt-trigger, bi-directional pin. Open-drain output with 16-mA sink capability
I/O _{24t}	- TTL-level, bi-directional pin. Open-drain output with 24-mA sink capability
O _{12p3}	- 3.3V output pin with 12-mA source-sink capability
O _{12tp3}	- 3.3V, TTL-level output pin with 12-mA source-sink capability
O ₈	- TTL-level output pin with 8-mA source-sink capability
O ₁₂	- TTL-level output pin with 12-mA source-sink capability
O ₂₄	- TTL-level output pin with 24-mA source-sink capability
OD ₈	- Open-drain output pin with 8-mA sink capability
OD ₁₂	- Open-drain output pin with 12-mA sink capability
OD ₂₄	- Open-drain output pin with 24-mA sink capability
I/O _{V3}	- Bi-direction pin with source capability of 6 mA and sink capability of 1 mA



5.1 LPC Interface

SYMBOL	PIN	I/O	DESCRIPTION
IOCLK	18	IN _{tp3}	System clock input, either 24MHz or 48MHz. The actual frequency must be specified in the register. The default value is 48MHz.
PME#	86	OD _{12p3}	Generated PME event.
PCICLK	21	IN _{tsp3}	PCI-clock 33-MHz input.
LDRQ#	22	O _{12p3}	Encoded DMA Request signal.
SERIRQ	23	I/OD _{12tp3}	Serialized IRQ input / output.
LAD[3:0]	24-27	I/O _{12tp3}	These signal lines communicate address, control, and data information over the LPC bus between a host and a peripheral.
LFRAME#	29	IN _{tsp3}	Indicates the start of a new cycle or the termination of a broken cycle.
LRESET#	30	IN _{tsp3}	Reset signal. It can be connected to the PCIRST# signal on the host.

5.2 FDC Interface

SYMBOL	PIN	I/O	DESCRIPTION
DRVDEN0	1	OD ₂₄	Drive Density Select bit 0.
INDEX#	3	IN _{cs}	This Schmitt-trigger input from the disk drive is active-low when the head is positioned over the beginning of a track marked by an index hole. This input pin needs to connect a pulled-up 1-KΩ resistor to 5V for Floppy Drive compatibility.
MOA#	4	OD ₂₄	Motor A On. When set to 0, this pin activates disk drive A. This is an open-drain output.
DSA#	6	OD ₂₄	Drive Select A. When set to 0, this pin activates disk drive A. This is an open-drain output.
DIR#	8	OD ₂₄	Direction of the head step motor. An open-drain output. Logic 1 = outward motion Logic 0 = inward motion
STEP#	9	OD ₂₄	Step output pulses. This active-low open-drain output produces a pulse to move the head to another track.
WD#	10	OD ₂₄	Write data. This logic-low open-drain writes pre-compensation serial data to the selected FDD. An open-drain output.
WE#	11	OD ₂₄	Write enable. An open-drain output.
TRAK0#	13	IN _{cs}	Track 0. This Schmitt-trigger input from the disk drive is active-low when the head is positioned over the outermost track. This input pin needs to connect a pulled-up 1-KΩ resistor to 5V for Floppy Drive compatibility.



FDC Interface, continued

SYMBOL	PIN	I/O	DESCRIPTION
WP#	14	IN _{cs}	Write protected. This active-low Schmitt input from the disk drive indicates that the diskette is write-protected. This input pin needs to connect a pulled-up 1-KΩ resistor to 5V for Floppy Drive compatibility.
RDATA#	15	IN _{cs}	The read-data input signal from the FDD. This input pin needs to connect a pulled-up 1-KΩ resistor to 5V for Floppy Drive compatibility.
HEAD#	16	OD ₂₄	Head selection. This open-drain output determines which disk drive head is active. Logic 1 = side 0 Logic 0 = side 1
DSKCHG#	17	IN _{cs}	Diskette change. This signal is active-low at power-on and whenever the diskette is removed. This input pin needs to connect a pulled-up 1-KΩ resistor to 5V for Floppy Drive compatibility.

5.3 Multi-Mode Parallel Port

SYMBOL	PIN	I/O	DESCRIPTION
SLCT	31	IN _{ts}	PRINTER MODE: An active-high input on this pin indicates that the printer is selected. See the description of the parallel port for the definition of this pin in ECP and EPP modes.
PE	32	IN _{ts}	PRINTER MODE: An active-high input on this pin indicates that the printer has detected the end of the paper. See the description of the parallel port for the definitions of this pin in ECP and EPP modes.
BUSY	33	IN _{ts}	PRINTER MODE: An active-high input indicates that the printer is not ready to receive data. See the description of the parallel port for the definitions of this pin in ECP and EPP modes.
ACK#	34	IN _{ts}	PRINTER MODE: ACK# An active-low input on this pin indicates that the printer has received data and is ready to accept more data. See the descriptions of the parallel port for the definition of this pin in ECP and EPP modes.
ERR#	45	IN _{ts}	PRINTER MODE: ERR# An active-low input on this pin indicates that the printer has encountered an error condition. See the description of the parallel port for the definitions of this pin in ECP and EPP modes.
SLIN#	43	OD ₁₂	PRINTER MODE: SLIN# Output line for detection of printer selection. See the description of the parallel port for the definitions of this pin in ECP and EPP modes.



Multi-Mode Parallel Port, continued.

SYMBOL	PIN	I/O	DESCRIPTION
INIT#	44	OD ₁₂	PRINTER MODE: INIT# Output line for the printer initialization. See the description of the parallel port for the definitions of this pin in ECP and EPP modes.
AFD#	46	OD ₁₂	PRINTER MODE: AFD# An active-low output from this pin causes the printer to auto feed a line after a line is printed. See the description of the parallel port for the definitions of this pin in ECP and EPP modes.
STB#	47	OD ₁₂	PRINTER MODE: STB# An active-low output is used to latch the parallel data into the printer. See the description of the parallel port for the definitions of this pin in ECP and EPP modes.
PD0	42	I/O _{12ts}	PRINTER MODE: PD0 Parallel port data bus bit 0. See the description of the parallel port for the definitions of this pin in ECP and EPP modes.
PD1	41	I/O _{12ts}	PRINTER MODE: PD1 Parallel port data bus bit 1. See the description of the parallel port for the definitions of this pin in ECP and EPP modes.
PD2	40	I/O _{12ts}	PRINTER MODE: PD2 Parallel port data bus bit 2. See the description of the parallel port for the definitions of this pin in ECP and EPP modes.
PD3	39	I/O _{12ts}	PRINTER MODE: PD3 Parallel port data bus bit 3. See the description of the parallel port for the definitions of this pin in ECP and EPP modes.
PD4	38	I/O _{12ts}	PRINTER MODE: PD4 Parallel port data bus bit 4. See the description of the parallel port for the definition of this pin in ECP and EPP modes.
PD5	37	I/O _{12ts}	PRINTER MODE: PD5 Parallel port data bus bit 5. See the description of the parallel port for the definitions of this pin in ECP and EPP modes.
PD6	36	I/O _{12ts}	PRINTER MODE: PD6 Parallel port data bus bit 6. See the description of the parallel port for the definitions of this pin in ECP and EPP modes.
PD7	35	I/O _{12ts}	PRINTER MODE: PD7 Parallel port data bus bit 7. See the description of the parallel port for the definitions of this pin in ECP and EPP modes.



5.4 Serial Port & Infrared Port Interface

SYMBOL	PIN	I/O	DESCRIPTION
RIA#	57	IN _t	Ring Indicator. An active-low signal indicates that a ring signal is being received from the modem or the data set.
GP60		I/OD _{12t}	General-purpose I/O port 6 bit 0.
DCDA#	56	INT	Data Carrier Detection. An active-low signal indicates the modem or data set has detected a data carrier.
GP61		I/OD _{12t}	General-purpose I/O port 6 bit 1.
SOUTA	54	O ₈	UART A Serial Output. This pin is used to transmit serial data out to the communication link.
PENKBC		IN _t	During power on reset, this pin is pulled down internally and is defined as PENKBC, and the power-on values are shown at CR24 bit 2. The PCB layout should reserve space for a 1-kΩ resistor to pull down this pin to ensure the disabling of KBC, and a 1-kΩ resistor is recommended to pull the pin up if wish to enable KBC.
GP62		I/O ₈	General-purpose I/O port 6 bit 2.
SINA	53	IN _t	Serial Input. This pin is used to receive serial data through the communication link.
GP63		I/OD _{12t}	General-purpose I/O port 6 bit 3.
DTRA#	52	O ₈	UART A Data Terminal Ready. An active-low signal informs the modem or data set that the controller is ready to communicate.
PENROM		IN _t	During power-on reset, this pin is pulled down internally and is defined as PENROM disabled, and the power-on values are shown at CR24 bit 1 (ENROM). The PCB layout should reserve space for a 1-kΩ resistor to pull down this pin to ensure the disabling of SPI interface, and a 1-kΩ resistor is recommended to pull the pin up if wish to enable ROM.
GP64		I/O ₈	General-purpose I/O port 6 bit 4.
RTSA#	51	O ₈	UART A Request To Send. An active-low signal informs the modem or data set that the controller is ready to send data.
HEFRAS		IN _t	During power-on reset, this pin is pulled down internally and is defined as HEFRAS, which provides the power-on value for CR26 bit 6 (HEFRAS). The PCB layout should reserve space for a 1-kΩ resistor to pull down this pin so as to ensure the selection of I/O port's configuration address to 2EH, and a 1-kΩ resistor is recommended to pull it up if 4EH is selected as I/O port's configuration address.
GP65		I/O ₈	General-purpose I/O port 6 bit 5.
DSRA#	50	IN _t	Data Set Ready. An active-low signal indicates the modem or data set is ready to establish a communication link and transfer data to the UART.
GP66		I/OD _{12t}	General-purpose I/O port 6 bit 6.



Serial Port & Infrared Port Interface , continued.

SYMBOL	PIN	I/O	DESCRIPTION
CTSA#	49	IN _t	Clear To Send. This is the modem-control input. The function of these pins can be tested by reading bit 4 of the handshake status register.
GP67		I/OD _{12t}	General-purpose I/O port 6 bit 7.
RIB#	85	IN _t	Ring Indicator. An active-low signal indicates that a ring signal is being received from the modem or the data set.
GP40*		I/OD _{12t}	General-purpose I/O port 4 bit 0.
DCDB#	84	IN _t	Data Carrier Detection. An active-low signal indicates the modem or data set has detected a data carrier.
GP41***		I/OD _{12t}	General-purpose I/O port 4 bit 1.
FAN_SET2	83	IN _t	Determines the initial FAN speed. Power-on configuration for 2 fan speeds, 50% or 100%. When VCC is on, this pin needs a pulled-up or a pulled-down resistor to decide whether the fan speed is 50% or 100%. Only CPUFANOUT1 is supported.
SOUTB		O ₁₂	UART B Serial Output. This pin is used to transmit serial data out to the communication link.
IRTX			IR Transmitter output.
GP42*		I/O _{12t}	General-purpose I/O port 4 bit 2. Note: This pin changes to input state during internal PWROK from low to high, then goes back to the previous setting state. (Please see the AP Note 1 of W83627DHG)
SINB	82	IN _t	Serial Input. This pin is used to receive serial data through the communication link.
IRRX			IR Receiver input.
GP43***		I/OD _{12t}	General-purpose I/O port 4 bit 3.
DTRB#	81	O ₁₂	UART B Data Terminal Ready. An active-low signal informs the modem or data set that the controller is ready to communicate.
GP44*		I/OD _{12t}	General-purpose I/O port 4 bit 4.
RTSB#	80	O ₁₂	UART B Request To Send. An active-low signal informs the modem or data set that the controller is ready to send data.
GP45***		I/OD _{12t}	General-purpose I/O port 4 bit 5.
DSRB#	79	IN _t	Data Set Ready. An active-low signal indicates the modem or data set is ready to establish a communication link and transfer data to the UART.
GP46*		I/OD _{12t}	General-purpose I/O port 4 bit 6.
CTSB#	78	IN _t	Clear To Send. This is the modem-control input. The function of these pins can be tested by reading bit 4 of the handshake status register.
GP47***		I/OD _{12t}	General-purpose I/O port 4 bit 7.

Note: Regarding the * sign, please see 5.11.8 GPIO-4 for detailed WDTO# / SUSLED multi-function information.